onsemi

MOSFET - Power, Single N-Channel, SUPERFET[®], FAST, TO247-4L 600 V, 41 mΩ, 57 A NTH4LNO41N60S5H

Description

The SUPERFET V MOSFET FAST series helps maximize system efficiency by the extremely low switching losses in hard switching application.

Features

- 650 V @ $T_J = 150^{\circ}C / Typ. R_{DS(on)} = 32.8 \text{ m}\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free / BFR Free and RoHS Compliant

Applications

- Telecom / Server Power Supplies
- EV Charger / UPS / Solar / Industrial Power Supplies

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

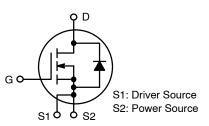
Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	600	V
Gate-to-Source Voltage	DC	V _{GS}	±30	V
	AC (f > 1 Hz)		±30	
Continuous Drain Current	$T_{C} = 25^{\circ}C$	Ι _D	57	А
	$T_{C} = 100^{\circ}C$		36	
Power Dissipation	$T_{C} = 25^{\circ}C$	PD	329	W
Pulsed Drain Current (Note 1)	T _C = 25°C	I _{DM}	200	А
Pulsed Source Current (Body Diode) (Note 1)		I _{SM}	200	
Operating Junction and Storage Te Range	T _J , T _{stg}	–55 to +150	°C	
Source Current (Body Diode)		I _S	57	А
Single Pulse Avalanche Energy	$I_L = 8 \text{ A},$ $R_G = 25 \Omega$	E _{AS}	560	mJ
Avalanche Current		I _{AS}	8	А
Repetitive Avalanche Energy (Note 1)		E _{AR}	3.29	mJ
MOSFET dv/dt		dv/dt	120	V/ns
Peak Diode Recovery dv/dt (Note		20		
Lead Temperature for Soldering Purposes (1/8" from case for 10 seconds)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

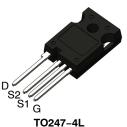
1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{SD} \leq$ 28.5 A, di/dt \leq 200 A/µs, $V_{DD} \leq$ 400 V, starting T_J = 25°C.

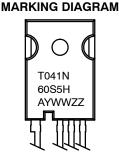
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
600 V	41 mΩ @ 10 V	57 A	



N-CHANNEL MOSFET



TO247-4L CASE 340CW



T041N60S5H = Specific Device Code

- = Assembly Location
- Y = Year

А

- WW = Work Week
- ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NTH4LN041N60S5H	TO247-4L	30 Units / Tube

THERMAL CHARACTERISTICS

Reverse Recovery Charge

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	0.38	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

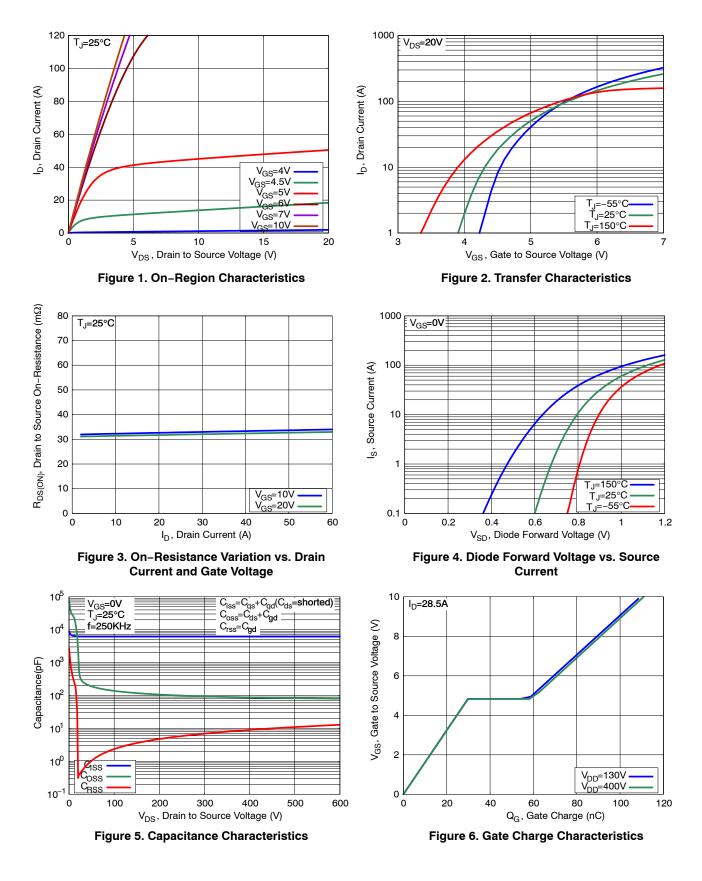
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•					
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	600	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	${\Delta V_{(BR)DSS}}/{\Delta T_J}$	I_D = 10 mA, Referenced to 25°C	_	630	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 600 V, T_{J} = 25°C	-	-	2	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTERISTICS	-		-	-	-	
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_{D} = 28.5 A, T_{J} = 25°C	-	32.8	41	mΩ
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 6.7 mA, T_J = 25°C	2.7	-	4.3	V
Forward Transconductance	9 _{FS}	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 28.5 \text{ A}$	-	60.3	-	S
CHARGES, CAPACITANCES & GATE R	ESISTANCE	•				
Input Capacitance	C _{ISS}	V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz	-	6213	-	pF
Output Capacitance	C _{OSS}		-	87.3	-	
Time Related Output Capacitance	C _{OSS(tr)}	$I_D = Constant, V_{DS} = 0 \text{ to } 400 \text{ V}, \\ V_{GS} = 0 \text{ V}$	-	1369	-	
Energy Related Output Capacitance	C _{OSS(er)}	V_{DS} = 0 to 400 V, V_{GS} = 0 V	-	146	-	
Total Gate Charge	Q _{G(TOT)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 28.5 \text{ A},$	-	110	-	nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = 10 V	-	29.9	-	
Gate-to-Drain Charge	Q _{GD}		-	29.4	-	
Gate Resistance	R _G	f = 1 MHz	-	0.73	-	Ω
SWITCHING CHARACTERISTICS	-		-	-	-	
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = 0/10 \text{ V}, \text{ V}_{DD} = 400 \text{ V},$	-	38.1	-	ns
Rise Time	tr	I_D = 28.5 A, R_G = 2.2 Ω	-	10.5	-	1
Turn-Off Delay Time	t _{d(OFF)}		-	93.7	-	1
Fall Time	t _f		-	2.76	-	1
SOURCE-TO-DRAIN DIODE CHARACT	ERISTICS	•	•	•	•	•
Forward Diode Voltage	V _{SD}	I_{SD} = 28.5 A, V_{GS} = 0 V, T_{J} = 25°C	-	-	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, I_{SD} = 28.5 A,$	-	462	-	ns
Reverse Recovery Charge	Q _{BB}	dl/dt =100 A/μs, V _{DD} = 400 V	_	9428	_	nC

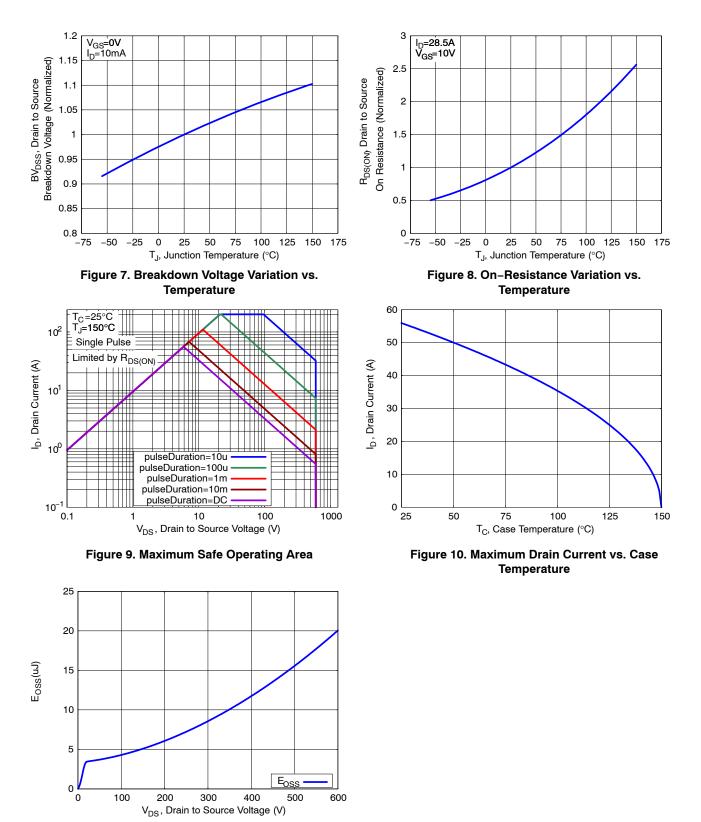
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Q_{RR}

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

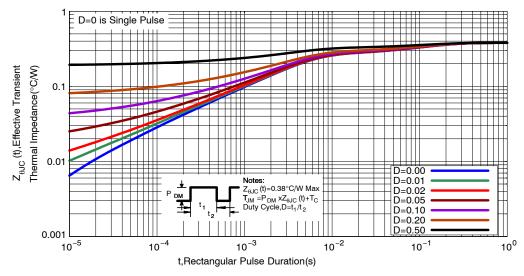
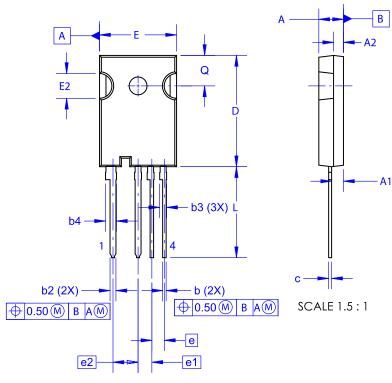


Figure 12. Transient Thermal Impedance

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PACKAGE DIMENSIONS

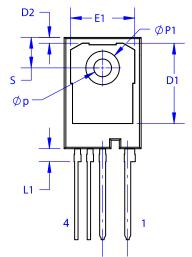
TO-247 4-LEAD, THIN LEADS CASE 340CW ISSUE A



SCALE 1.5 : 1

NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.



SCALE 1.5:1

	MILLIMETERS				
DIM	MIN	NOM	MAX		
A	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	0.57	0.70	0.83		
b2	1.07	1.20	1.33		
b3	1.20	1.40	1.60		
b4	2.02	2.22	2.42		
с	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.30	16.50		
D2	0.97	1.17	1.37		
е		2.54			
e1		2.79			
e2		5.08			
E	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E2	4.80	5.00	5.20		
L	18.12	18.42	18.72		
L1	2.42	2.62	2.82		
Øp	3.40	3.60	3.80		
ØP1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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